

Global Circuit Material Market Size Study, by Material Class, by Substrate, by Conducting Material, by Outer Layer, by Application, and by Region - Global Forecast 2017- 2025

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Abstracts

Global Circuit Material Market to reach USD xxxx billion by 2025.

Global Circuit Material Market valued approximately USD xxxx billion in 2016 is anticipated to grow with a healthy growth rate of more than xx% over the forecast period 2017-2025. The Global circuit materials market has been segmented into material class, substrate, conducting material, outer layer, application, and region. Based on material class, the circuit materials market has been classified into substrate, conducting material, and outer layer. The fiberglass-epoxy is the most demanded substrate of circuit materials. The growth of the fiberglass-epoxy substrate segment can be attributed to the high focus of manufacturers on the products offering better properties such as high strength and high resistance to fire. This led fiberglass-epoxy substrate to account for a large share of the global circuit materials market.

The objective of the study is to define market sizes of different segments & countries in recent years and to forecast the values to the coming years. The report is designed to incorporate both qualitative and quantitative aspects of the industry within each of the regions and countries involved in the study. Furthermore, the report also caters the detailed information about the crucial aspects such as driving factors & challenges which will define the future growth of the market. Additionally, the report shall also incorporate available opportunities in micro markets for stakeholders to invest along with the detailed analysis of competitive landscape and product offerings of key players. The detailed segments and sub-segment of the market are explained below:

By Material Class:

Substrate

Conducting Material

Outer Layer

By Substrate:

Fiberglass-Epoxy

Paper- Phenolic

CEM

Polymide

By Conducting Material:

Copper

Other

By Outer Layer:

Liquid Ink Photoimageable Solder Mask

Dry Film Photoimageable

Others

By Application:

Communication

Industrial Electronics

Automotive

Aerospace & Defense

By Regions:

North America

U.S.

Canada

Europe

UK

Germany

Asia Pacific

China

India

Japan

Latin America

Brazil

Mexico

Rest of the World

Furthermore, years considered for the study are as follows:

Historical year – 2015

Base year – 2016

Forecast period – 2017 to 2025

Some of the key manufacturers involved in the market are – Isola Group, Taiflex Scientific Co.Ltd, Rogers Corporation, Eternal Material Co.Ltd, Jinan Guoji Technology Ltd, Dowdupont, ITECQ Corporation, Kingboard Laminates Holding Ltd, Shengyi Technology Co Ltd

Acquisitions and effective mergers are some of the strategies adopted by the key manufacturers. New product launches and continuous technological innovations are the key strategies adopted by the major players.

Target Audience of the Global Circuit Material Marketin Market Study:

Key Consulting Companies & Advisors

Large, medium-sized, and small enterprises

Venture capitalists

Value-Added Resellers (VARs)

Third-party knowledge providers

Investment bankers

Investors

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